## Product Change Notification - KSRA-04FQJT080

Date:	12 Sep 2017								
Product Category:	Memory								
lotification subject:	CCB 3089 Initial Notice: Qualification of UNIS as a new assembly site for selected Atmel Memory								
	products available in 8	L WLCSP package.							
lotification text:	PCN Status: Initial notification								
	initial notification								
	Microchip Parts Affected								
	Please open the attachments found in the attachments field below labeled as PCN_#_Affected_CPN.								
	NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).								
	Description of Change:	new assembly site for selecte	d Atmel Memory products	s available in 8L WLCSP packa					
	Qualification of onlig as a	new assembly site for selecte	a Amerinemory produce	s available in or wrecor packa					
	Pre Change:								
	Assembled at ASEK and JCAP								
	Post Change:								
	Assembled at UNIS								
	Pre and Post Change Summary:								
	<b>[</b> ]	Pre Change Post Change							

 

 Under Bump Metallurgy (UBM)
 Al(sp)-NiV(sp)-Cu(sp)
 Ti(sp)-Cu(sp)-Cu(sp)

 Solder Ball
 SAC 405
 SAC 405

Impacts to Data Sheet: None

**Redistribution Layer** 

(RDL)

Change Impact: None

Reason for Change: To improve on time delivery performance by qualifying UNIS as new assembly site

Ti(sp)-Al(sp)-Ti(sp)

Ti(sp)-Cu(sp)-Cu(pl)

Ti(sp)-Cu(sp)-Cu(pl)

Ti(sp)-Cu(sp)-Cu(pl)

SAC 405

Change Implementation Status: In Progress

Estimated Qualification Completion Date: February 2018

Note: Please be advised the qualification completion times may be extended because of unforeseen business conditions however implementation will not occur until after qualification has completed and a final PCN has been issued. The final PCN will include the qualification report and estimated first ship date. Also note that after the estimated first ship date guided in the final PCN customers may receive pre and post change parts.

## Time Table Summary:

	September 2017				>	February 2018					
Workweek	35	36	37	38	39		5	6	7	8	9
Initial PCN Issue Date			х								
Qual Report Availability								х			
Final PCN Issue Date								х			

Method to Identify Change: Traceability code

Qualification Plan: Please open the attachments included with this PCN labeled as PCN\_#\_Qual Plan

Revision History: September 12, 2017: Issued initial notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

## Attachment(s):

PCN\_KSRA-04FQJT080\_Affected CPN.pdf PCN\_KSRA-04FQJT080\_Qual Plan.pdf PCN\_KSRA-04FQJT080\_Affected CPN.xlsx

Please contact your local Microchip sales office with questions or concerns regarding this notification.

## **Terms and Conditions:**

If you wish to change your product/process change notification (PCN) profile please log on to our website at http://www.microchip.com/PCN sign into myMICROCHIP to open the myMICROCHIP home page, then select a profile option from the left navigation bar.

To opt out of future offer or information emails (other than product change notification emails), click here to go to microchipDIRECT and login, then click on the "My account" link, click on "Update profile" and un-check the box that states "Future offers or information about Microchip's products or services."

KSRA-04FQJT080-CCB 3089 Initial Notice: Qualification of UNIS as a new assembly site for selected Atmel Memory products available in 8L WLCSP package.

Affected Catalog Part Numbers (CPN)

PCN_KSRA-04FQJT080
CATALOG_PART_NBR
AT24C512C-U1UM-T
AT24C512C-UUMEY-T
AT24C512C-UUMHC-T
AT24C512C-UUMHC-T-020
AT24CM01-U1UMGY-T
AT24CM01-U1UMGY-T-020
AT24CM01-U2UMHJ-T
AT24CM01-UUMJC-T-923
AT24CM01-UUM-T
AT24CM02-U1UM0B-T
AT24CM02-U1UM1B-T
AT24CM02-U2UM-T
AT25080B-UULHN-T
AT25M01-UUM-T
AT25M02-U1UM0B-T